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jc960 U.S. PTO

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07-12-01

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Docket No.: M-11706 US

July 10, 2001

Box Patent Application
Commissioner For Patents
Washington, D. C. 20231

Enclosed herewith for filing is a patent application, as follows:

Inventor(s): Martin, Kirk

Title: Method And Apparatus For Etching A Semiconductor Die

☒ Return Receipt Postcard
☒ This Transmittal Letter (in duplicate)
20 page(s) Specification (not including claims)
7 page(s) Claims
1 page Abstract
7 Sheet(s) of Drawings (Figs. 1, 2, 3, 4, 5, 6, 7 and 8)
1 page(s) Declaration For Patent Application and Power of Attorney
1 page(s) Recordation Form Cover Sheet (in duplicate)
☒ page(s) Assignment
☒ Applicant(s) assert(s) entitlement to small entity status for the attached patent application

CLAIMS AS FILED (fees computed under 37 CFR §1.9(f))

For	Number Filed		Number Extra		Rate		Basic Fee
Total Claims	34	-20 =	14	x	\$ 9.00 =	\$	355.00 126.00
Independent Claims	5	-3 =	2	x	\$40 =	\$	80.00

Please make the following charges to Deposit Account 19-2386:

- ☒ Total fee for filing the patent application in the amount of \$ 561.00
☒ The Commissioner is hereby authorized to charge any additional fees which may be required, or credit any overpayment to Deposit Account 19-2386.

EXPRESS MAIL LABEL NO:

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Respectfully submitted,

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